

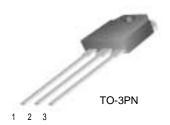
FFA30U60DN

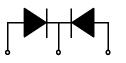
Features

- High voltage and high reliability
- High speed switching
- Low forward voltage

Applications

- General purpose
- Switching mode power supply
- Free-wheeling diode for motor application
- · Power switching circuits





1. Anode 2. Cathode 3. Anode

ULTRA FAST RECOVERY POWER RECTIFIER

Absolute Maximum Ratings (per diode) T_C=25°C unless otherwise noted

Symbol	Parameter	Value	Units
V _{RRM}	Peak Repetitive Reverse Voltage	600	V
I _{F(AV)}	Average Rectified Forward Current @ T _C = 100°C	30	А
I _{FSM}	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave	180	А
T _{J,} T _{STG}	Operating Junction and Storage Temperature	- 65 to +150	°C

Thermal Characteristics

Symbol	Parameter	Value	Units	
R _{e,IC}	Maximum Thermal Resistance, Junction to Case	0.8	°C/W	

Electrical Characteristics (per diode) T_C=25 °C unless otherwise noted

Symbol	Parameter		Min.	Тур.	Max.	Units
/ _{FM} *	Maximum Instantaneous Forward Voltage	T 05.00			0.0	V
	$I_F = 30A$	T _C = 25 °C T _C = 100 °C	-	-	2.3	
	$I_F = 30A$	$T_C = 100 ^{\circ}C$	-	-	2.1	
RM *	Maximum Instantaneous Reverse Current					μΑ
	@ rated V _R	$T_C = 25 ^{\circ}C$	-	-	15	
		$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$	-	-	150	
rr	Maximum Reverse Recovery Time		-	-	90	ns
rr	Maximum Reverse Recovery Current		-	-	8	Α
Q _{rr}	Maximum Reverse Recovery Charge (I _F =30A, di/dt = 200A/μs)		-	-	360	nC
N _{AVL}	Avalanche Energy		1.0	-	-	mJ

^{*} Pulse Test: Pulse Width=300µs, Duty Cycle=2%

Typical Characteristics

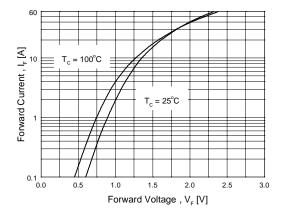


Figure 1. Typical Forward Voltage Drop vs. Forward Current

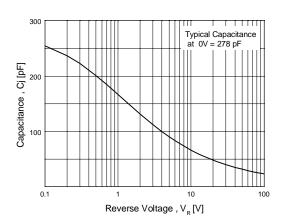


Figure 3. Typical Junction Capacitance

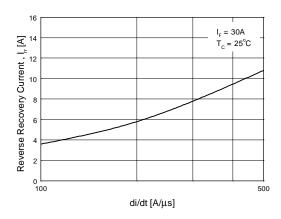


Figure 5. Typical Reverse Recovery Current vs. di/dt

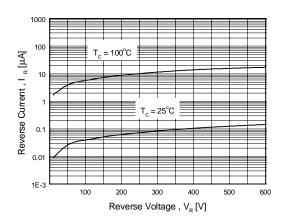


Figure 2. Typical Reverse Current vs. Reverse Voltage

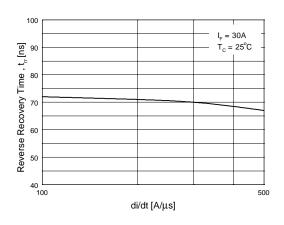


Figure 4. Typical Reverse Recovery Time vs. di/dt

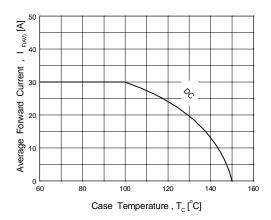
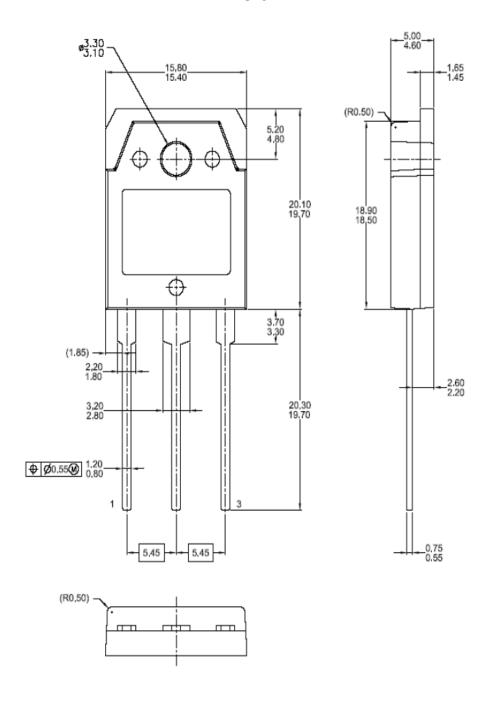


Figure 6. Forward Current Derating Curve

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Mechanical Dimensions

TO-3PN



Dimensions in Millimeters

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